TOSHIBA Field-Effect Transistor Silicon P-Channel MOS Type

SSM6P35FE

- High-Speed Switching Applications
- Analog Switch Applications
- 1.2-V drive

• Low ON-resistance : R_{ON} = 44 Ω (max) (@V_{GS} = -1.2 V)

: R_{ON} = 22 Ω (max) (@V_{GS} = -1.5 V) : R_{ON} = 11 Ω (max) (@V_{GS} = -2.5 V) : R_{ON} = 8 Ω (max) (@V_{GS} = -4.0 V)

Absolute Maximum Ratings (Ta = 25°C) (Common to the Q1, Q2)

Characteristics		Symbol	Rating	Unit	
Drain-source voltage		V_{DSS}	-20	V	
Gate-source voltage		V_{GSS}	±10	V	
Drain current	DC	ΙD	-100	mA	
	Pulse	I _{DP}	-200		
Drain power dissipation		P _D (Note 1)	150	mW	
Channel temperature		T _{ch}	150	°C	
Storage temperature		T _{stg}	–55 to 150	°C	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in

1.6±0.05
1.2±0.05
1.2±0.05
6
6
90.0+0:1
1.5ource1 4.Source2
ES6 2.Gate1 5.Gate2
3.Drain2 6.Drain1

JEDEC JEITA TOSHIBA 2-2N1D

Weight: 3.0 mg (typ.)

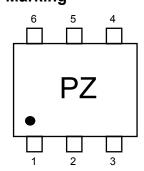
temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Total rating

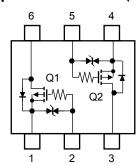
Mounted on an FR4 board

 $(25.4 \text{ mm} \times 25.4 \text{ mm} \times 1.6 \text{ mm}, \text{ Cu Pad: } 0.135 \text{ mm}^2 \times 6)$

Marking



Equivalent Circuit (top view)



Start of commercial production 2008-03

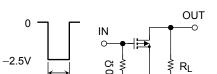
Electrical Characteristics (Ta = 25°C) (Common to the Q1, Q2)

Chara	cteristics	Symbol	Test Condition		Min	Тур.	Max	Unit
Gate leakage curr	ent	I _{GSS}	$V_{GS} = \pm 10 \text{ V}, V_{DS} = 0 \text{ V}$		_	_	±10	μА
Drain-source brea	kdown voltage	V (BR) DSS	$I_D = -0.1 \text{ mA}, V_{GS} = 0 \text{ V}$	_D = -0.1 mA, V _{GS} = 0 V		_	_	V
Drain cutoff currer	nt	I _{DSS}	V _{DS} = -20 V, V _{GS} = 0 V		_	_	-1	μА
Gate threshold vol	tage	V _{th}	$V_{DS} = -3 \text{ V}, I_{D} = -1 \text{ mA}$		-0.4	_	-1.0	V
Forward transfer a	dmittance	Y _{fs}	$V_{DS} = -3 \text{ V}, I_D = -50 \text{ mA}$	(Note 2)	77	_	_	mS
Durin assure ON assistance		R _{DS} (ON)	$I_D = -50 \text{ mA}, V_{GS} = -4 \text{ V}$	(Note 2)	_	4.3	8	Ω
			$I_D = -50 \text{ mA}, V_{GS} = -2.5 \text{ V}$	(Note 2)	_	5.6	11	
Drain–source ON-resistance	I _D = -5 mA, V _{GS} = -1.5 V		(Note 2)	_	8.2	22		
			$I_D = -2 \text{ mA}, V_{GS} = -1.2 \text{ V}$	(Note 2)	_	11	44	
Input capacitance Reverse transfer capacitance		C _{iss}	$V_{DS} = -3 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		_	12.2	_	pF
		C _{rss}			_	6.5	_	
Output capacitance		Coss			_	10.4	_	
Switching time	Turn-on time	t _{on}	$V_{DD} = -3 \text{ V}, I_D = -50 \text{ mA},$ $V_{GS} = 0 \text{ to } -2.5 \text{ V}$		_	175	_	20
	Turn-off time	t _{off}		_	251	_	ns	
Drain-source forward voltage		V _{DSF}	I _D = 100 mA, V _{GS} = 0 V	(Note 2)	_	0.83	1.2	V

Note 2: Pulse test

Switching Time Test Circuit (Common to the Q1, Q2)





 $V_{DD} = -3 V$

10 us

Duty ≤ 1% V_{IN} : t_r , $t_f < 5$ ns

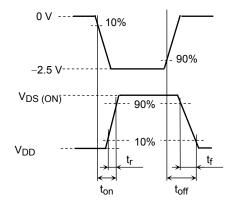
 $(Z_{OUt} = 50 \Omega)$

Common Source

 $Ta = 25^{\circ}C$

(b) VIN

(c) Vout



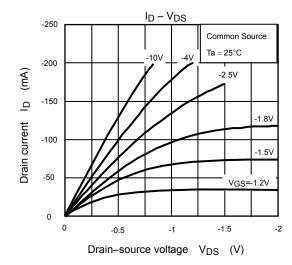
Usage Considerations

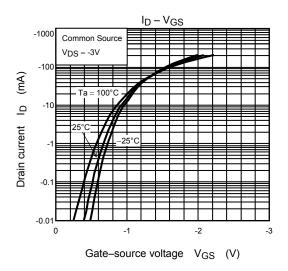
Let Vth be the voltage applied between gate and source that causes the drain current (ID) to below (-1 mA for the SSM6P35FE). Then, for normal switching operation, V_{GS(on)} must be higher than V_{th}, and V_{GS(off)} must be lower than $V_{th.}$ This relationship can be expressed as: $V_{GS(off)} < V_{th} < V_{GS(on).}$

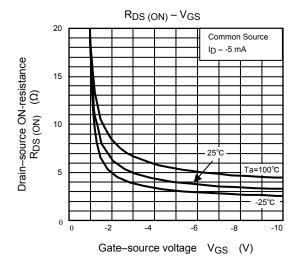
Take this into consideration when using the device.

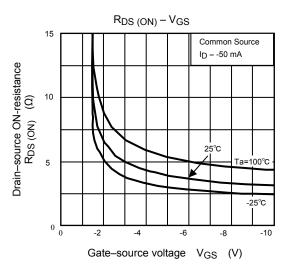
Handling Precaution

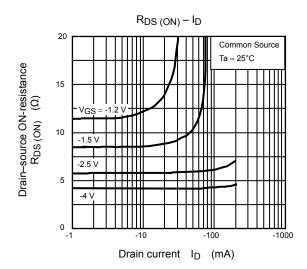
When handling individual devices that are not yet mounted on a circuit board, make sure that the environment is protected against electrostatic discharge. Operators should wear antistatic clothing, and containers and other objects that come into direct contact with devices should be made of antistatic materials.

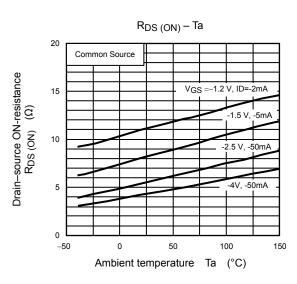


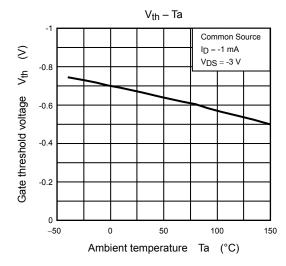


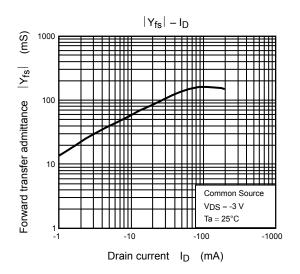


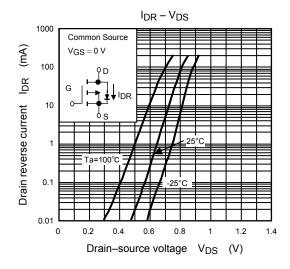


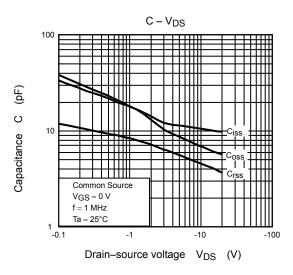


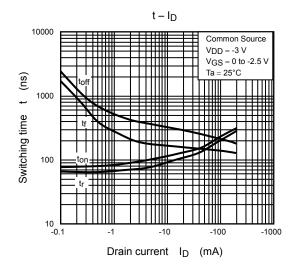


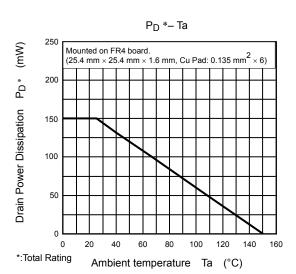












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